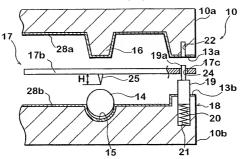
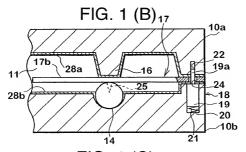
nie.

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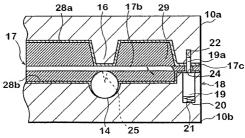
FIG. 1 (A)





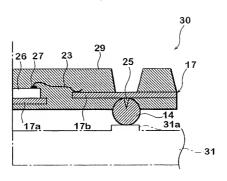


## FIG. 1 (C)



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FIG. 2

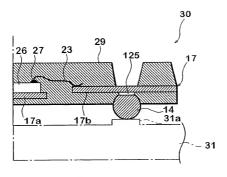


PACKAGE (1)

., . . . . . .

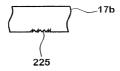
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FIG. 4



PACKAGE (2)

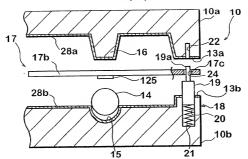
FIG. 5

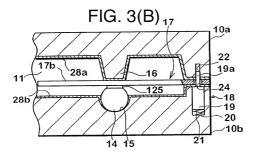


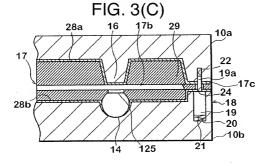
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FIG. 3(A)

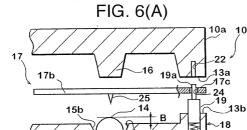


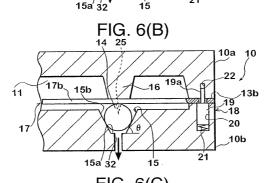




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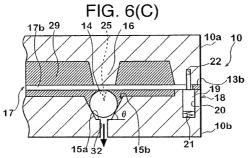




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20 10b

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FIG. 7(A)

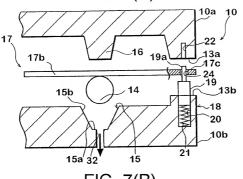
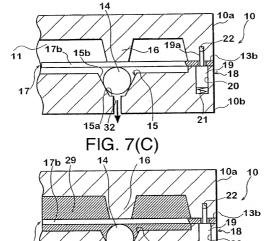


FIG. 7(B)



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15b

10b